

C0402C222M3TAC7411

SMD Comm X8G HT150C, Ceramic, 2,200 pF, 20%, 25 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0402, 0.3 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	1.06 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	2,200 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with	30 ppm/C, 1kHz 1.0Vrms
Reference to +25°C and 0 VDC Applied (TCC)	
Dissipation Factor	0.1% 1 kHz 1.0Vrms
	Capacitance Measurement Condition Tolerance Voltage DC Dielectric Withstanding Voltage Temperature Range Temp. Coefficient Capacitance Change with Reference to +25°C and O VDC Applied (TCC)

Aging Rate

Insulation Resistance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Dimensions Chip Size

Packaging

Packaging Specifications

Packaging Quantity

L W T S B

0% Loss/Decade Hour: Referee

Time is 1000 Hours

100 GOhms